

THE XEUS FOCAL PLANE INSTRUMENTS

Cryogenic Imaging X-ray Spectrometer (NFI), Cooling,
and X-ray polarimeter

Piet de Korte

On behalf of the XEUS Instrument Working Group

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Spectrometers
 - Lothar Strüder, HLL/MPE, G (co-chair)
 - Tadayuki Takahashi, JAXA, J
 - Dick Willingale, Leicester, UK
- High Time Resolution
X-ray Polarimeter
Cooling
Cryogenic Spectrometers
ESA instrument scientist
ESA Mission Scientist
Cryogenic
- DEPFET Si Drift Detectors
Hard X-ray Imager
X-ray optics

XEUS FOCAL PLANE INSTRUMENTS

Instrument	Mass (kg)	Power (W)
WFI Wide Field Imager Si-based DEPFET array (excl. baffle)	90	254
NFI Narrow Field Imager TES-based micro-calorimeter array (incl. cryostat + last cooler stage)	151	288
HXI Hard X-ray Imager CdTe-based imaging array (excl. baffle)	31	61
HTRS High Time Resolution Spectrometer Si-drift detectors	31	108
XPOL X-ray POLarimeter (XPOL) Gas proportional imager	15	44

REQUIREMENTS from XEUS Science Requirements Document_v5.

- X-ray Optics
 - 5 m² at 1 keV and 2 m² at 7 keV
 - 5 arcsec spatial resolution
- Field of View (arcmin)
 - 7' Ø (WFI); 1.7' Ø (NFI); 5' x 5' (HXI)
- Energy Range (keV)
 - 0.2 – 7 (NFI); 0.1 – 15 (WFI); 1 – 15 (HTRS); 1 – 40 (HXI)
- Energy Resolution
 - 150 eV @ 6 keV (WFI); 2 eV for E < 2 keV, and 6 eV @ 6 keV (NFI); 1 keV @ 40 keV (HXI)
- Count rate
 - 8 10³ c/s 1% pile-up (WFI); ?8 10³? c/s 10% pile-up (NFI); 2 10⁶ c/s 10% pile-up (HTRS)
- Polarimetry
 - 2% for 10 mCrab in 10 ks (XPOL); 2% for 2 mCrab in 100 ks (XPOL)

Mirror Driven Specifications

Long Focal Length gives **Large** Collection Area, but also **Large** detectors.

- **Angular Resolution**

5 arc sec resolution (Requirement) = 848 μ m

- **Field of View**

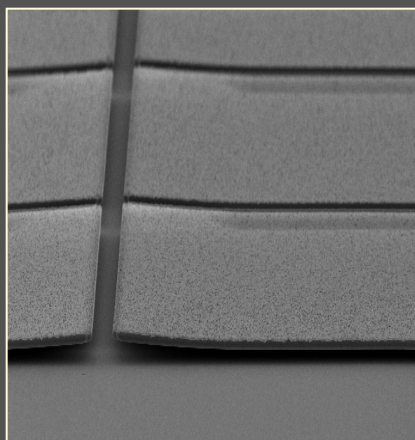
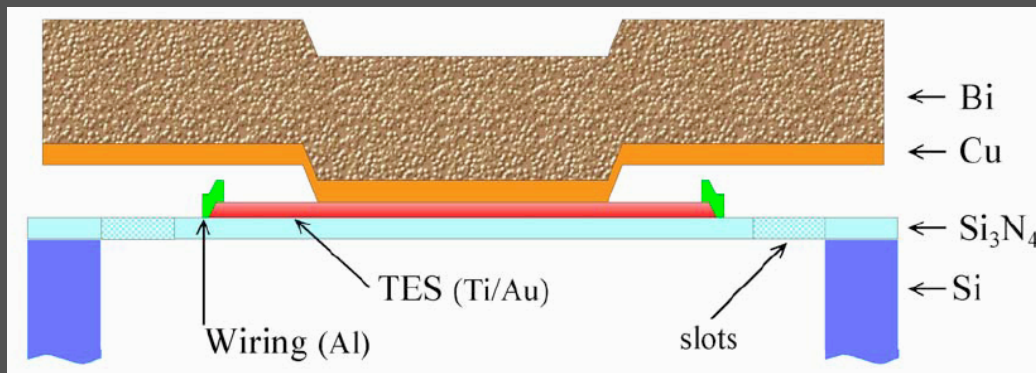
7 arc min radius = 71 mm

- **Large area**

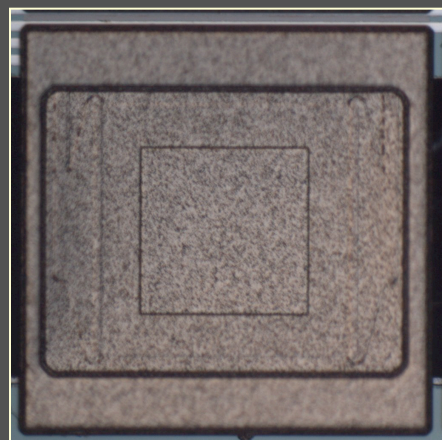
1mCrab \sim 300 c/sec

Narrow Field Imager - TES-based Micro-Calorimeter

PIXEL DESIGN

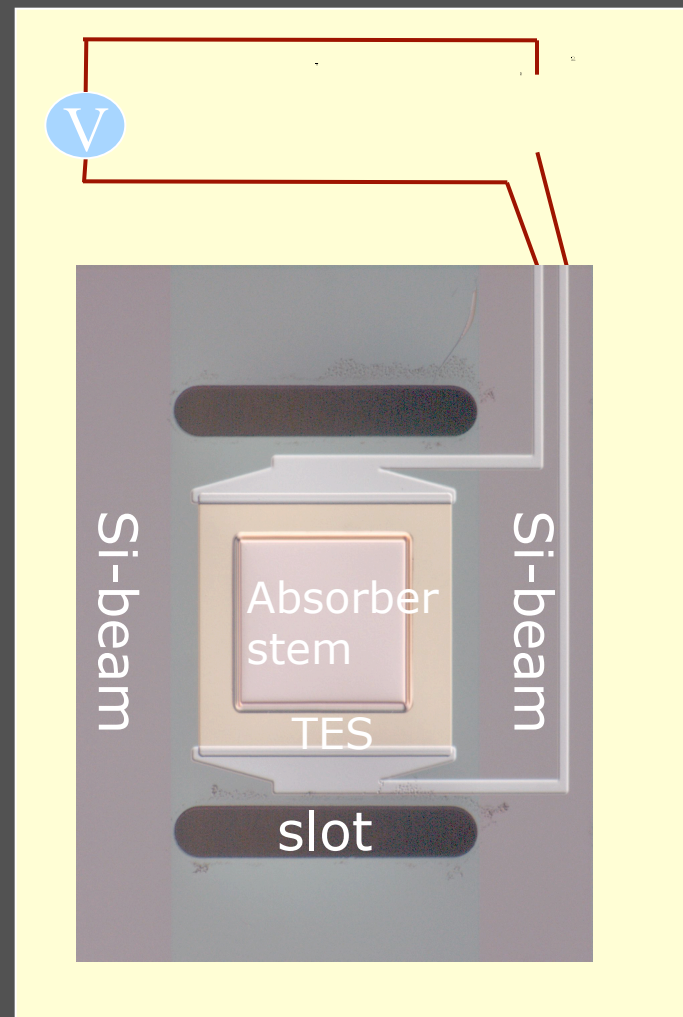


Side view



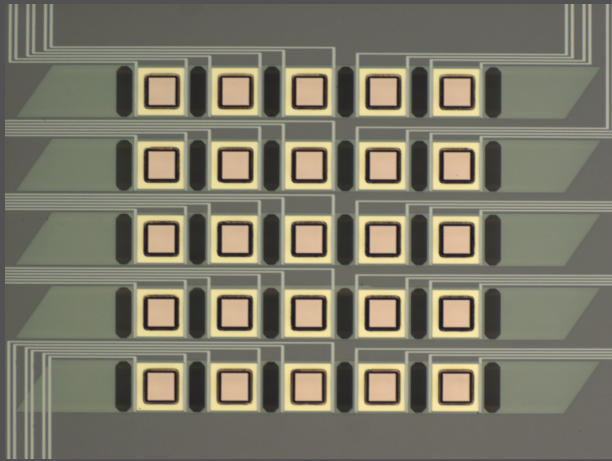
Top view

part of 5 x 5 array

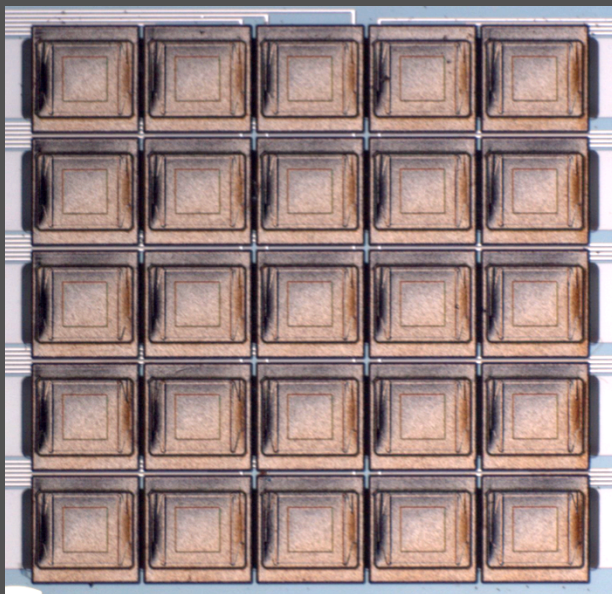


Narrow Field Imager - TES-based Micro-Calorimeter

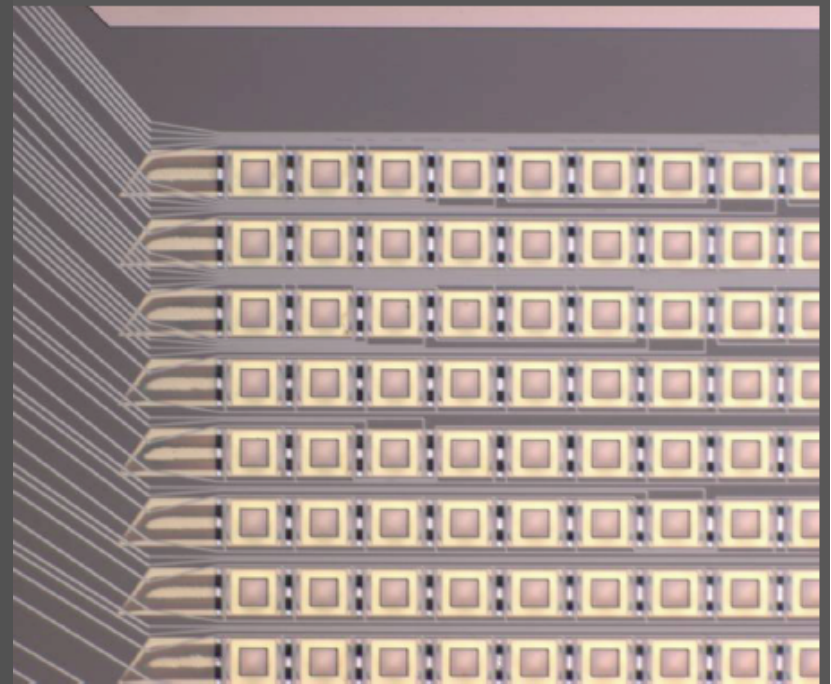
ARRAYS



5 x 5 array
with Cu stems



5 x 5 array
with Cu/Bi
absorbers

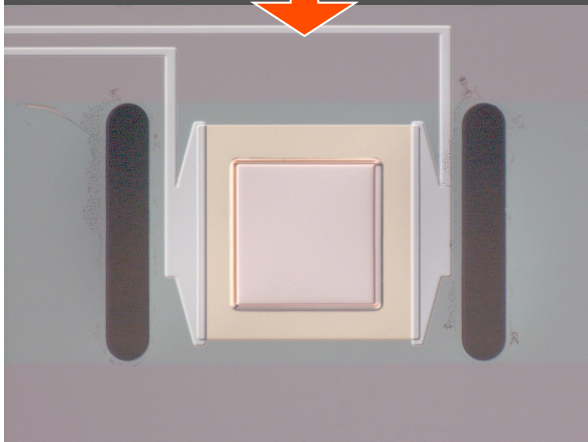


Close-up of 32 x 32 array

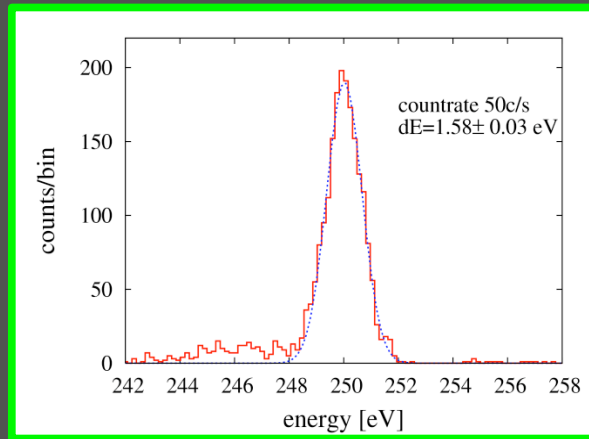
Narrow Field Imager - TES-based Micro-Calorimeter

PERFORMANCE for PIXELS from 5 x 5 arrays

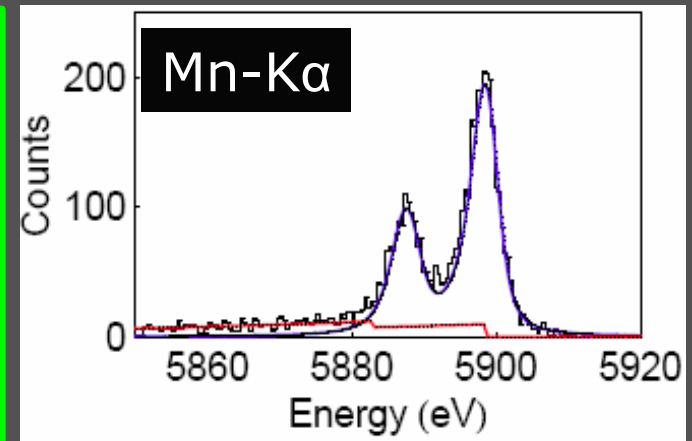
$\Delta E_{TDL} \approx 3.1 \text{ eV}$



Cu-absorber



$\Delta E = 1.6 \text{ eV @ } 250 \text{ eV}$

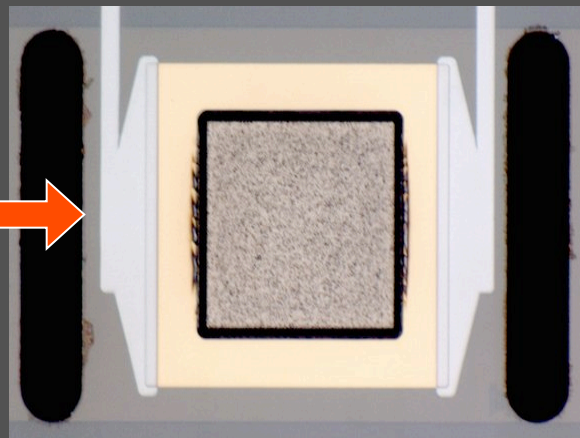


$\Delta E = 2.9 \text{ eV at } 5.9 \text{ keV}$

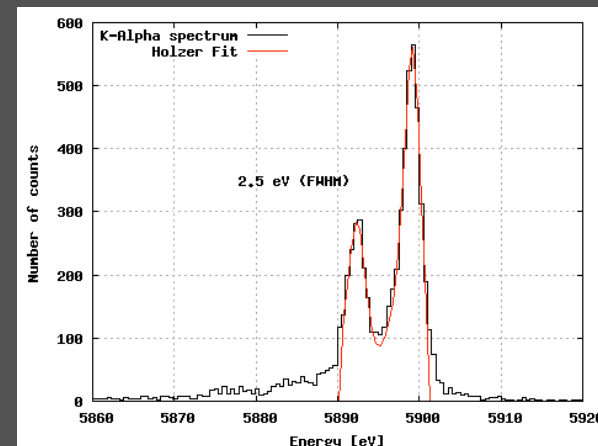
100 μs fall time

$\Delta E_{TDL} \approx 3.8 \text{ eV}$

$$\Delta E_{TDL} = 2.35 \sqrt{k_B T^2 C}$$



Cu/Bi-absorber



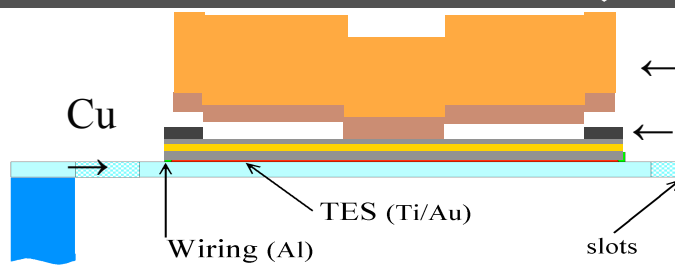
$\Delta E = 2.5 \text{ eV @ } 5.9 \text{ keV}$

Narrow Field Imager - TES-based Micro-Calorimeter

PERFORMANCE for PIXELS from 5 x 5 arrays

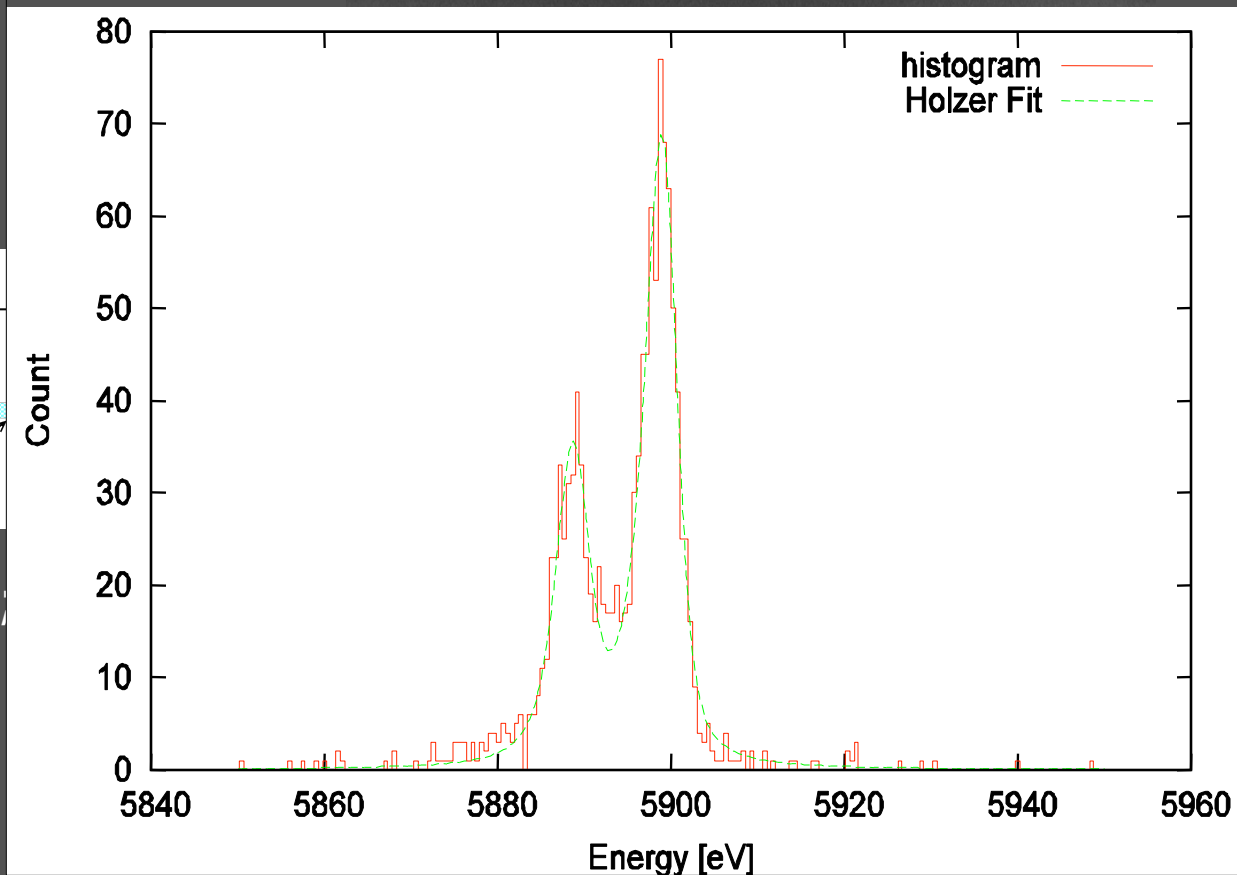
$$\Delta E_{TDL} = 2.35 \sqrt{k_B T^2 C}$$

$$\Delta E_{TDL} \approx 4.4 \text{ eV}$$



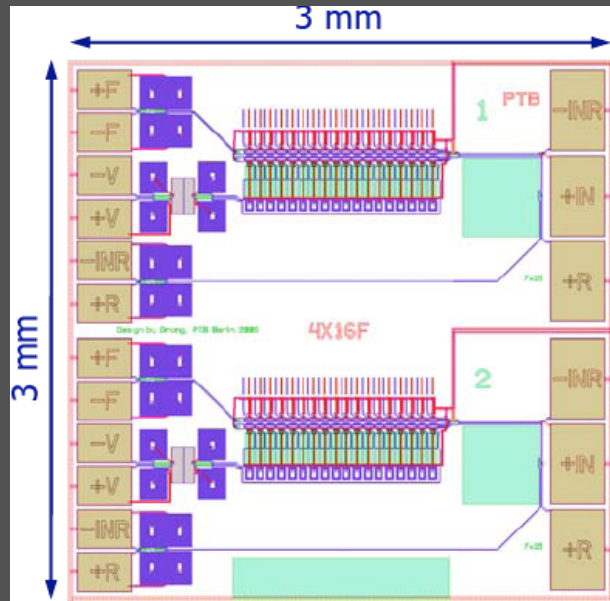
Cu/Bi-absorber (0.3/3 μm)
 $T_C = 116 \text{ mK}$

K-Alpha Spectrum of TT086-25-kw2-chip4-pix6 (2000 pulses, 3.10823 eV)



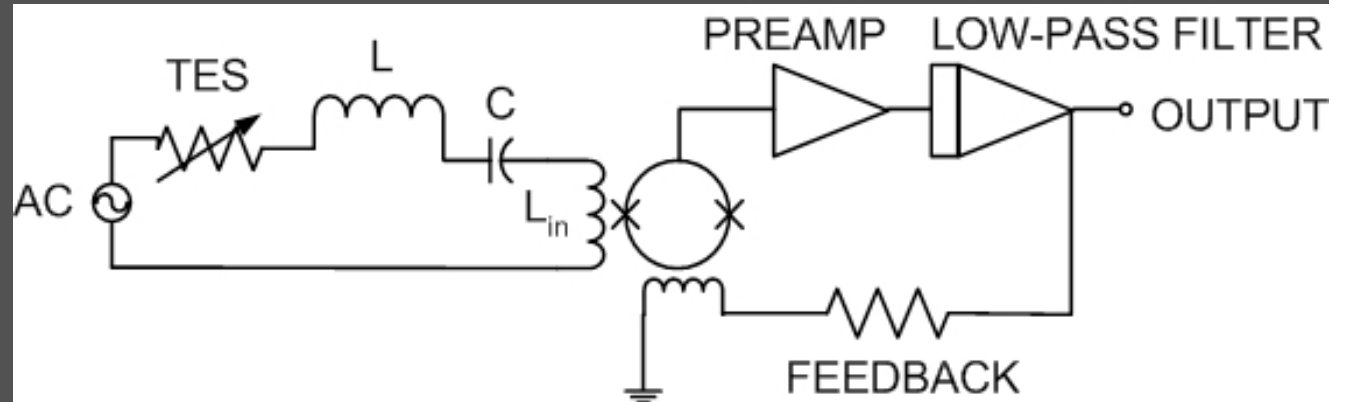
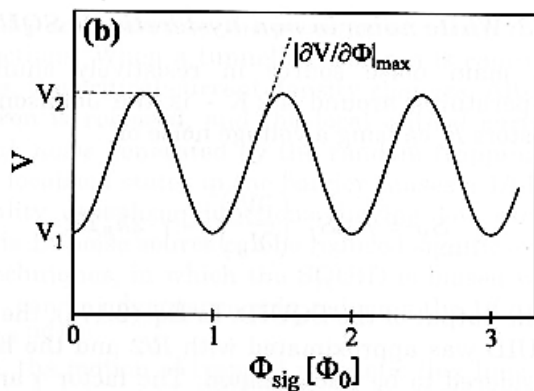
$\Delta E = 3.1 \text{ eV @ } 5.9 \text{ keV}$
200 μs fall time

MICRO-CALORIMETER READ-OUT BY SQUID AMPLIFIER

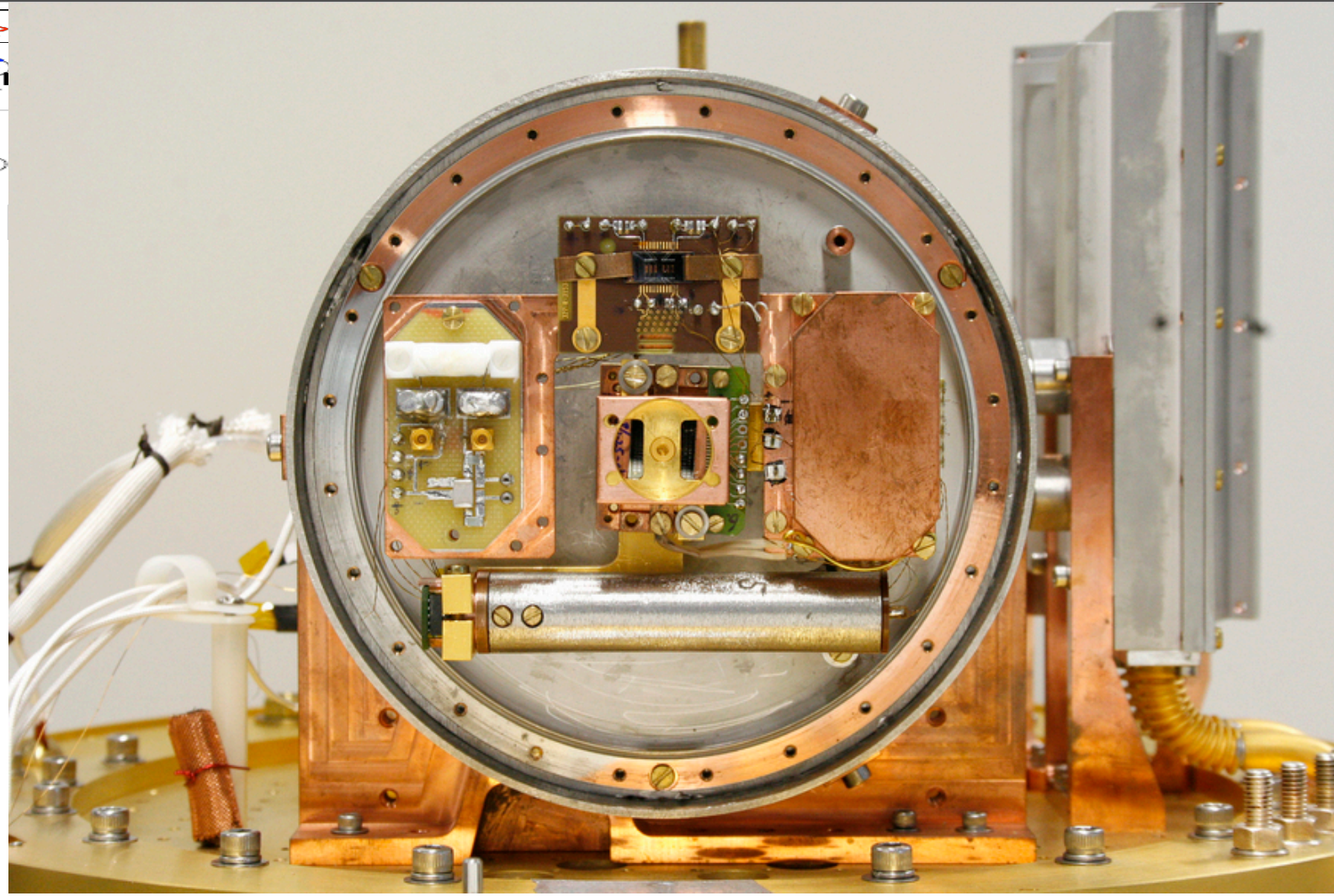
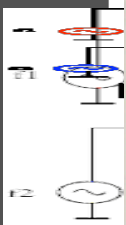


PTB 16-SQUID-arrays

- Amplifier of magnetic flux. Works at < 4 K, $P \sim 10$ nW
- Current transferred to flux by SQUID input coil
- SQUID "Linear" dynamic range typically $5 \cdot 10^5$ $\sqrt{\text{Hz}}$
- Feedback with gain ~ 10 required for linearization and dynamic range improvement (flux-locked-loop/FLL)
- Standard FLL not enough gain-bandwidth \rightarrow baseband feedback



FREQUENCY DOMAIN MULTIPLEXING CURRENT SUMMING TOPOLOGY



20

TES

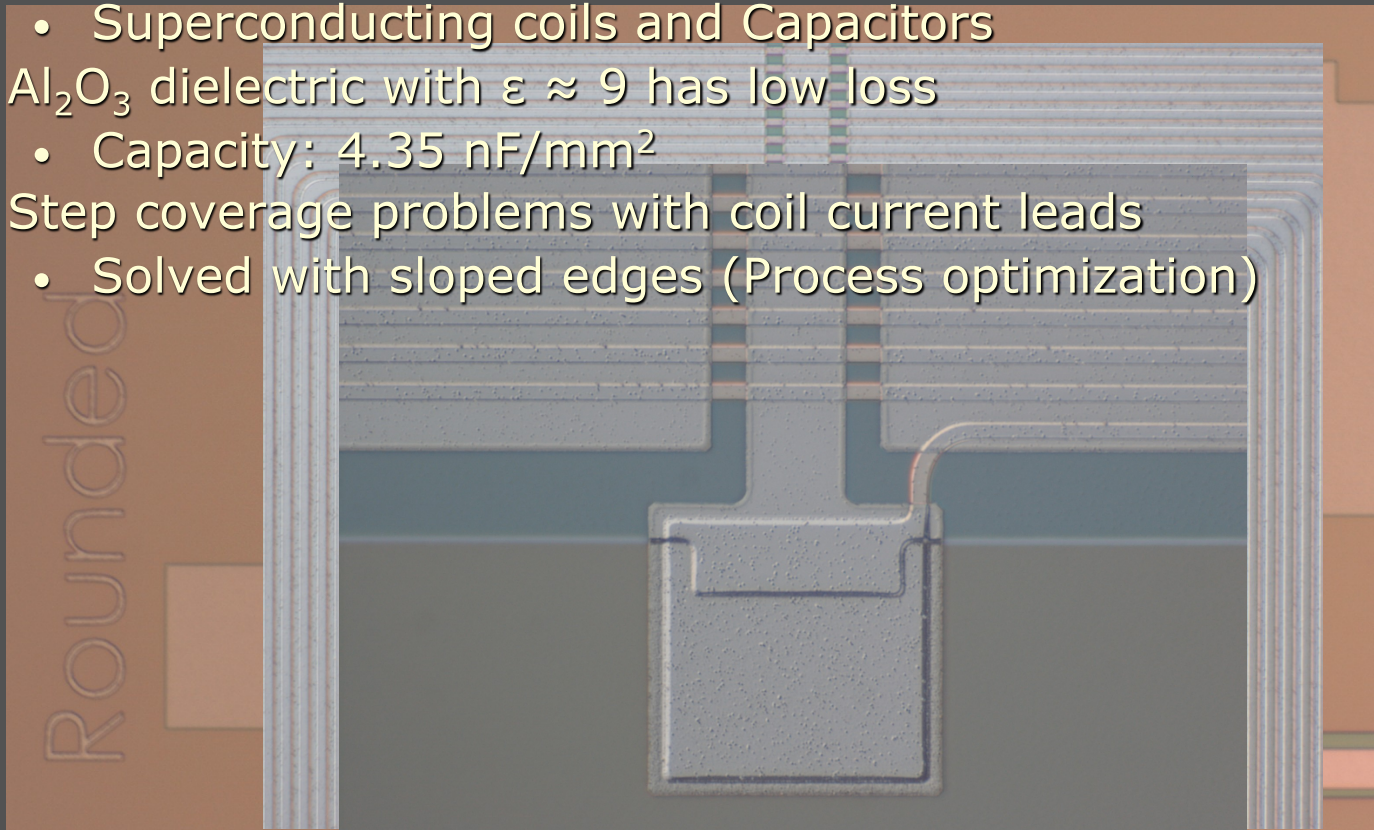
increase
size
ease

will
45

enable multiplication of 45
pixels/channel

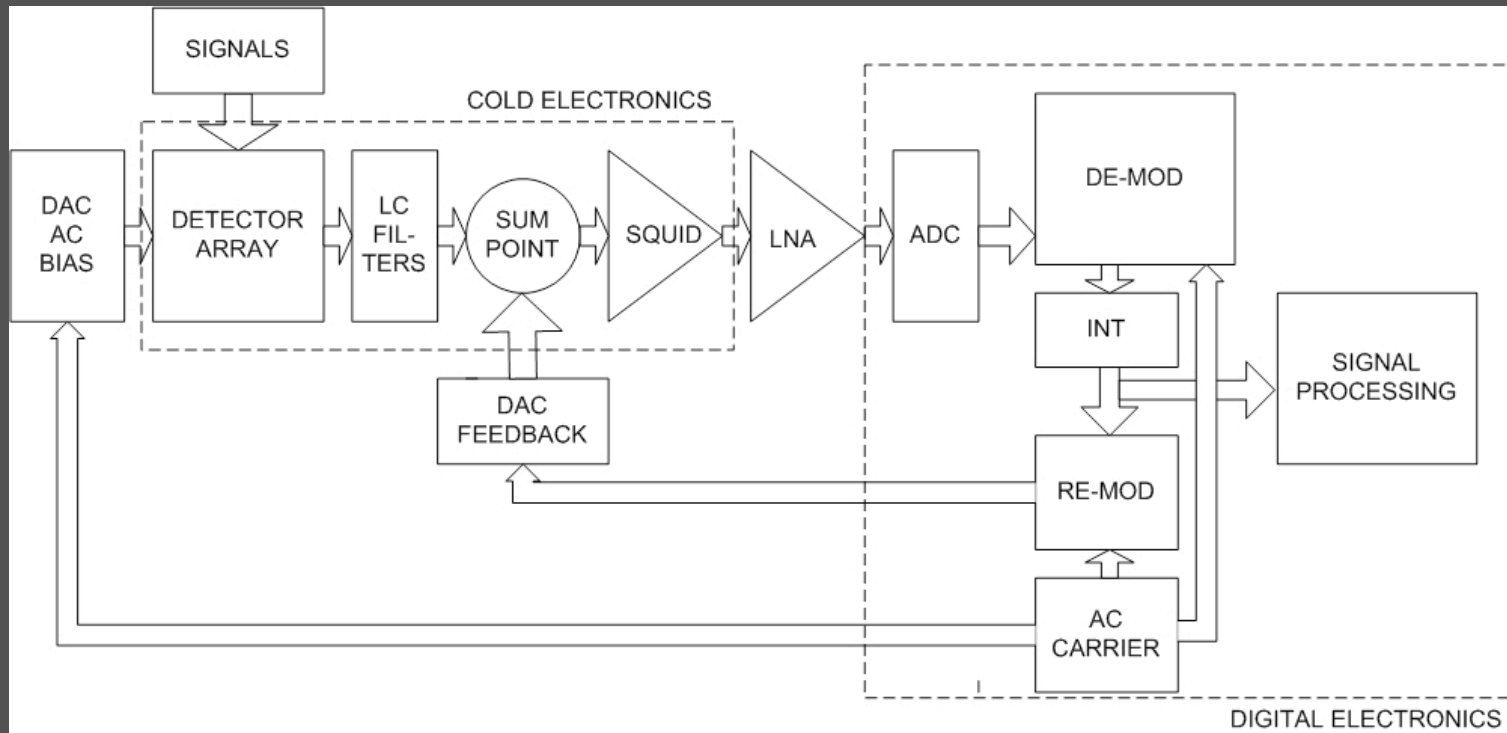
LC-filters

- Require high Q-factor, since $R_{\text{LOSS}} = \omega L/Q \ll R_{\text{BIAS}}$
 - $Q > 800.f$ (MHz)
 - Superconducting coils and Capacitors
- Al_2O_3 dielectric with $\epsilon \approx 9$ has low loss
 - Capacity: 4.35 nF/mm^2
- Step coverage problems with coil current leads
 - Solved with sloped edges (Process optimization)



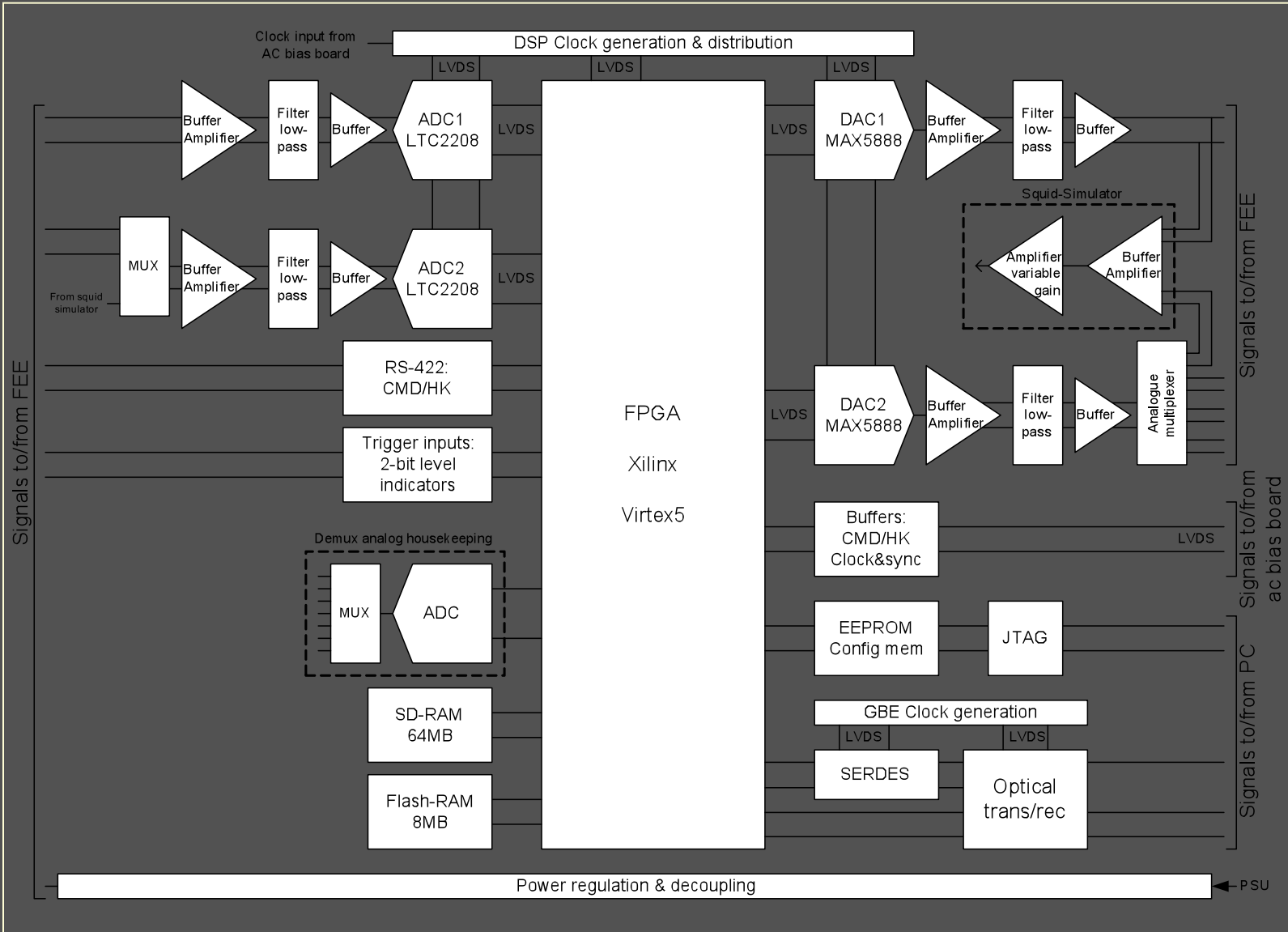
$Q > 4000$ measured and demonstrated

BASEBAND FEEDBACK

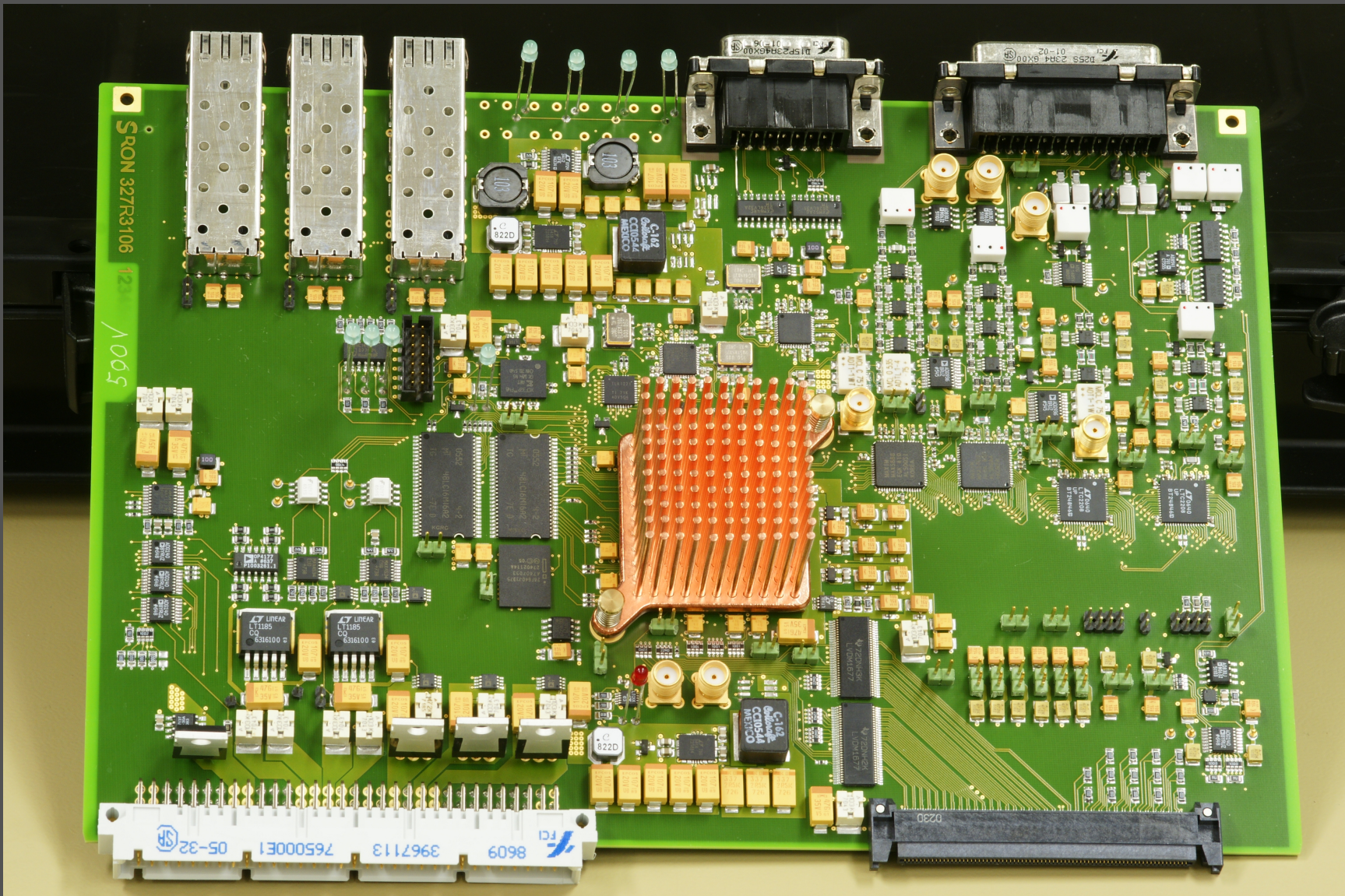


- Instability of feedback set by frequency separation of carriers (200 kHz) delay (250 ns) due to digitization and processing. Gain-bandwidth at base-band of about 30 kHz, so 3x feedback gain at highest signal frequency (10kHz)
- Performance tested on electrical breadboard.
- Bandwidth for carriers up to about 10 MHz (limited by SQUID back-action noise and LC-filter Q-factor)
- At least possible to multiplex 32 - 45 pixels XEUS type pixels

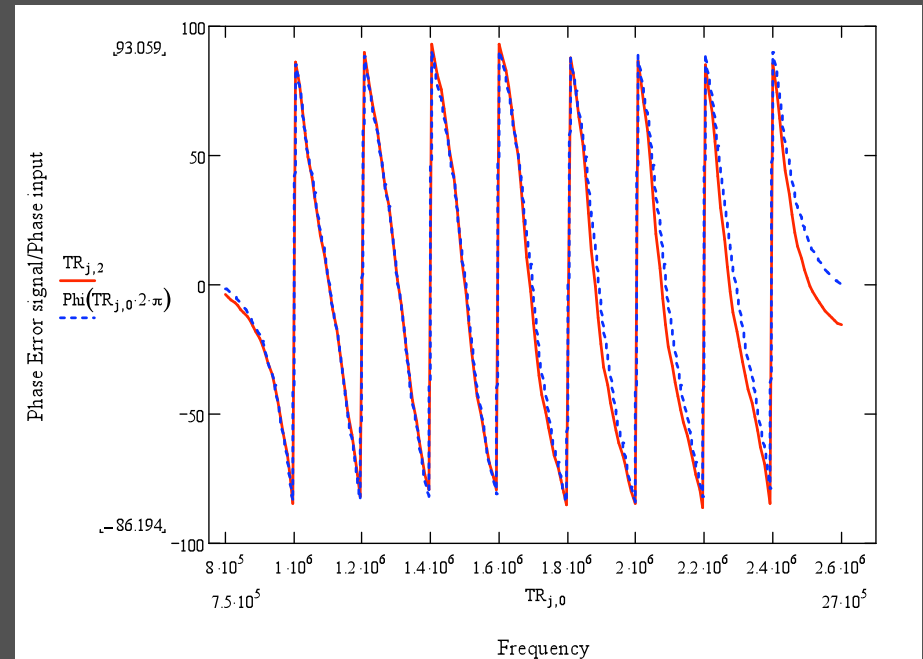
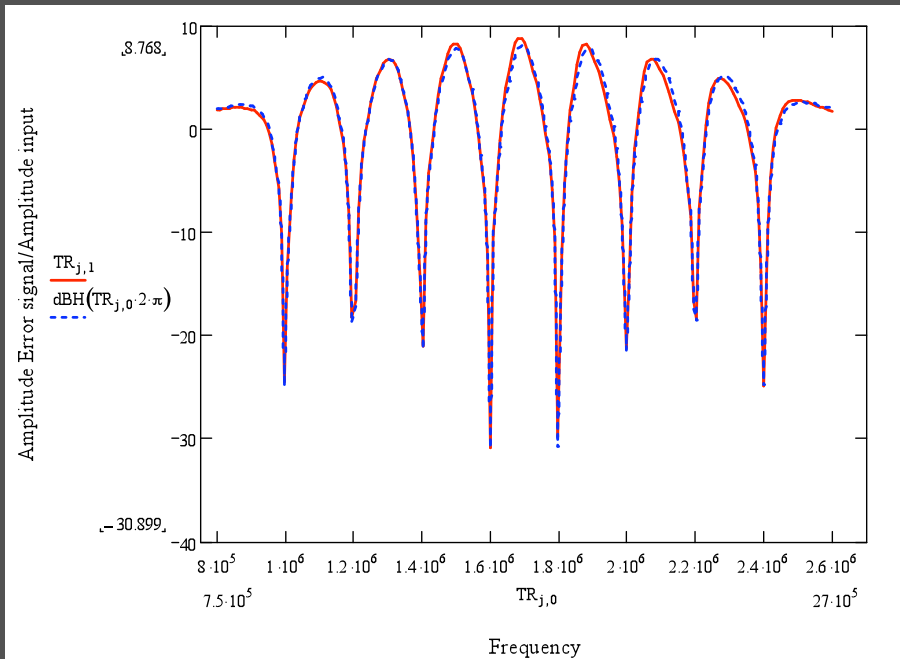
BaseBand Feedback Electronics board



BBFB electronics board realization



Amplitude and Phase measurements/model of BBFB On a commercial Xilinx breadboard

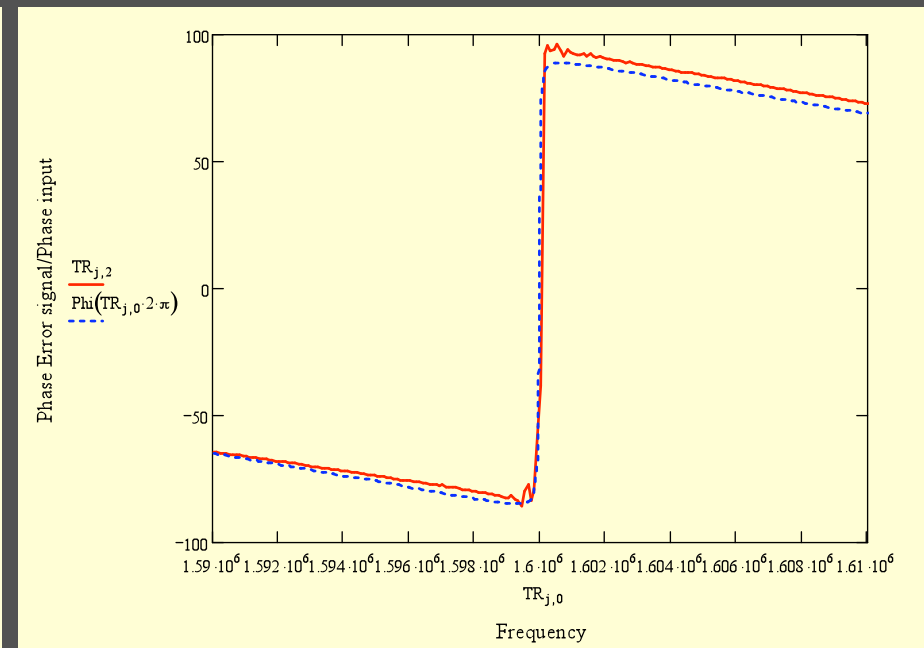
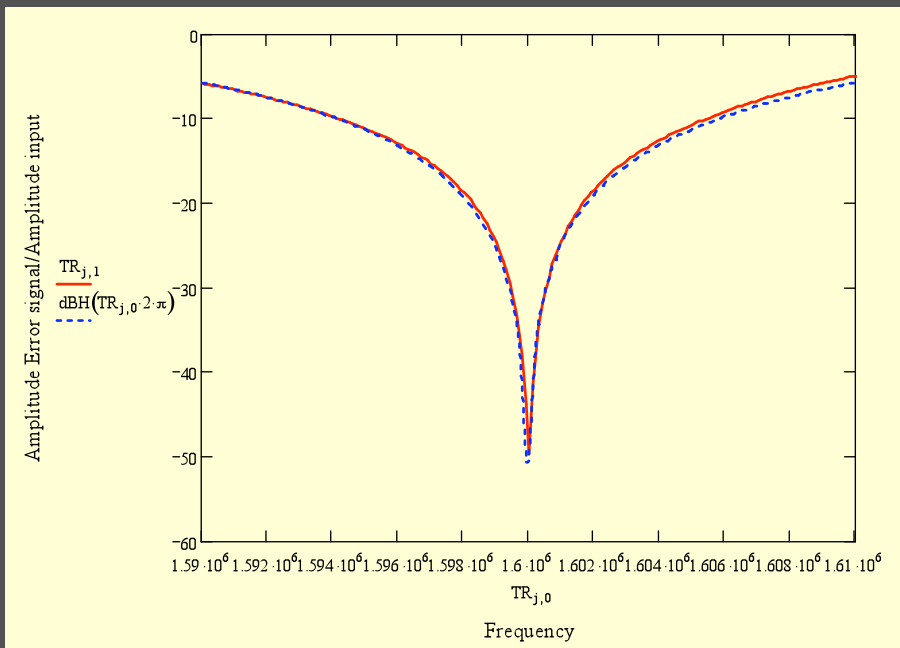


Amplitude: red-data blue-model Phase: red-data blue-model

Gain-bandwidth of 35 kHz for 200 kHz spacing and 830 ns delay

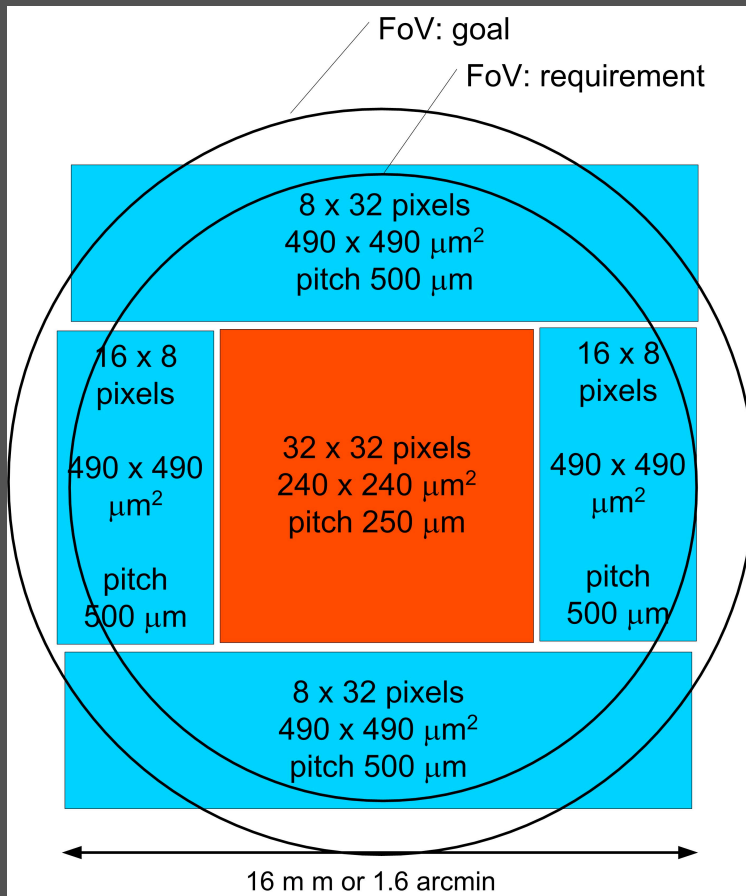
FLL-gain of 3.5x at highest signal frequency (10 kHz)

Amplitude and Phase measurements/model of BBFB On a commercial Xilinx breadboard

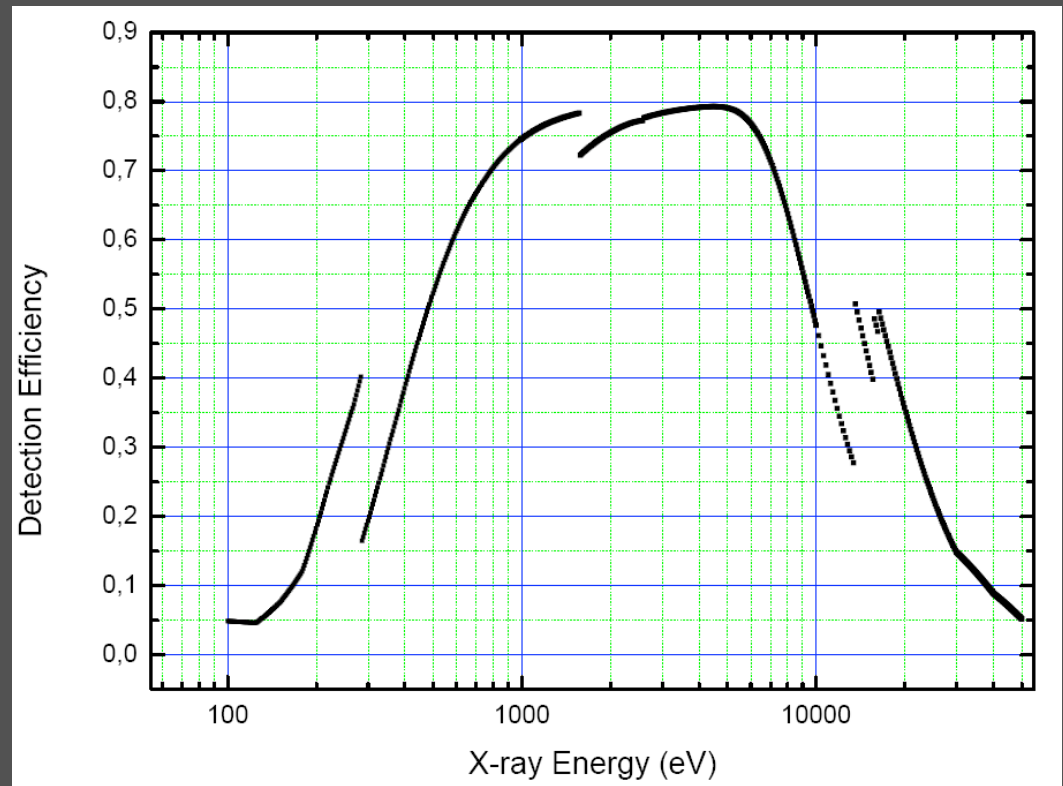


Measured carrier suppression – 50 dB
for a gain-bandwidth of 18 kHz

Narrow Field Imager - TES-based Micro-Calorimeter

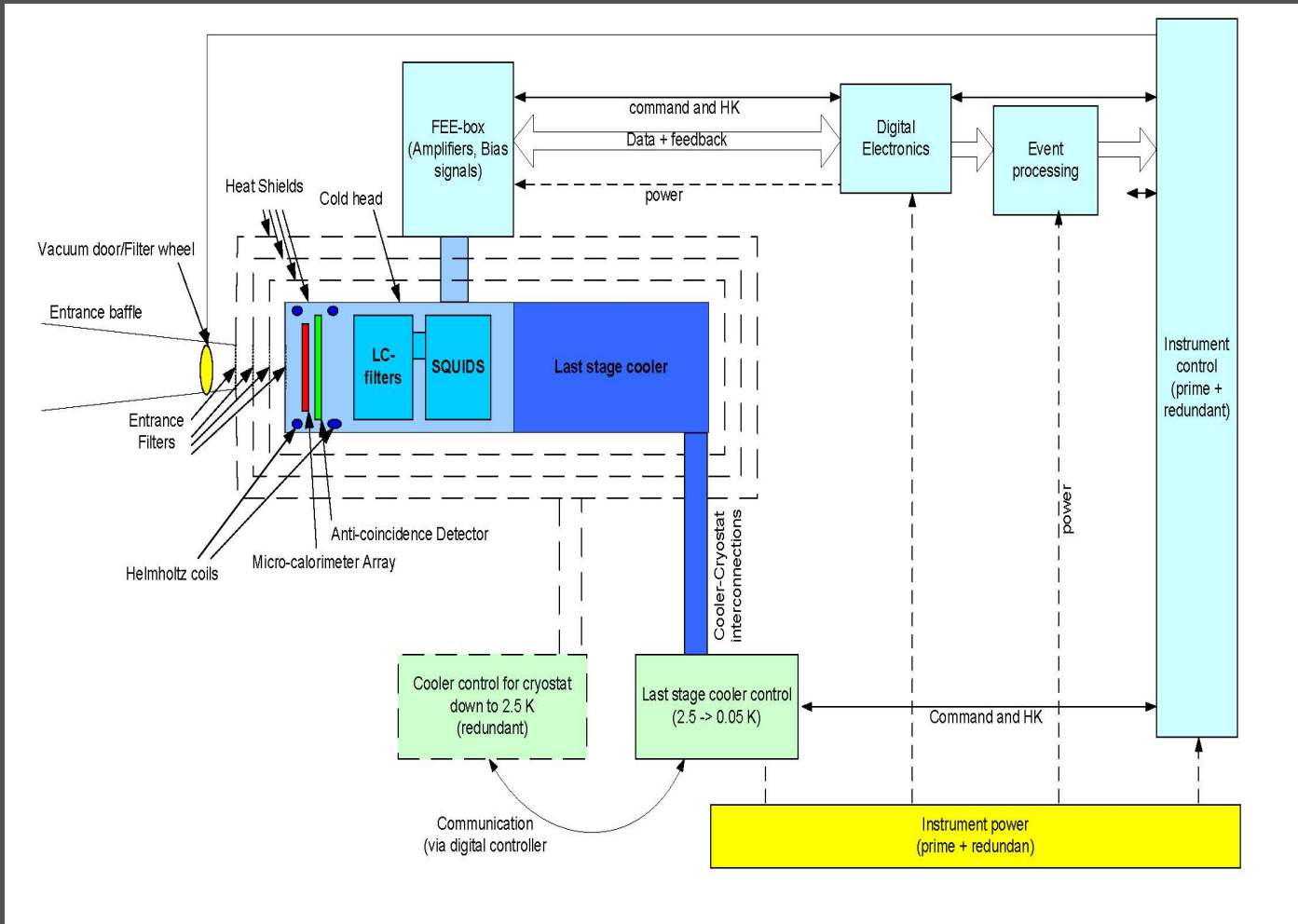


Field of View



Detection Efficiency (7 μm Bi)

Narrow Field Imager - TES-based Micro-Calorimeter



$\Delta E = 2 \text{ eV} < 2 \text{ keV}$
 1792 pixels for 1.7 arcmin diameter FoV
 Energy 0.2 – 10 keV
 Mass 151 kg (incl. last stage cooler)
 Power 217 W
 Requires 1 m long baffle

TES micro-calorimeters in EUROPE SRON and EURECA COLLABORATION

P. de Korte^[1], J. Anquita^a, F. Bakker, X. Barcons^b, P. Bastiaⁱ, J. Beyer^m, D. Boersma, F. Briones^a, M. Bruijn, J. Bussons^{b,c}, A. Camòn^d, F. Carrera^b, M. Ceballos^b, L. Colasantij, D. Drung^m, L. Fabrega^f, L. Ferrari^h, F. Gatti^h, R. Gonzalez-Arrabal^a, L. Gottardi, W. Hajdas^g, P. Helistö^l, J.W. den Herder, H. Hoevers, Y. Ishisakiⁿ, M. Kiviranta^l, J. van der Kuur, C. Macculli^j, A. Mchedlishvili^g, K. Mitsuda^o, B. Monna^p, R. Mossel, T. Ohashiⁿ, S. Pantali^q, M. Parra^d, L. Piro^j, R. Rohlf^s, J. Sésé^e, Y. Takei, G. Torrioli^k, H. van Weers, N. Yamasaki^o

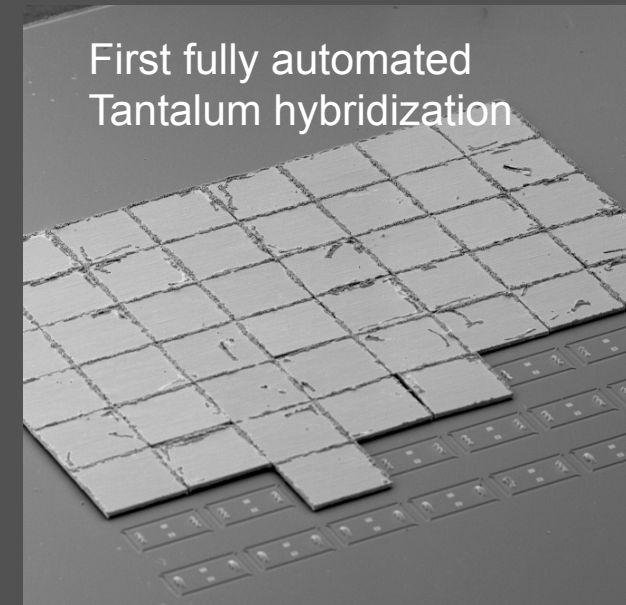
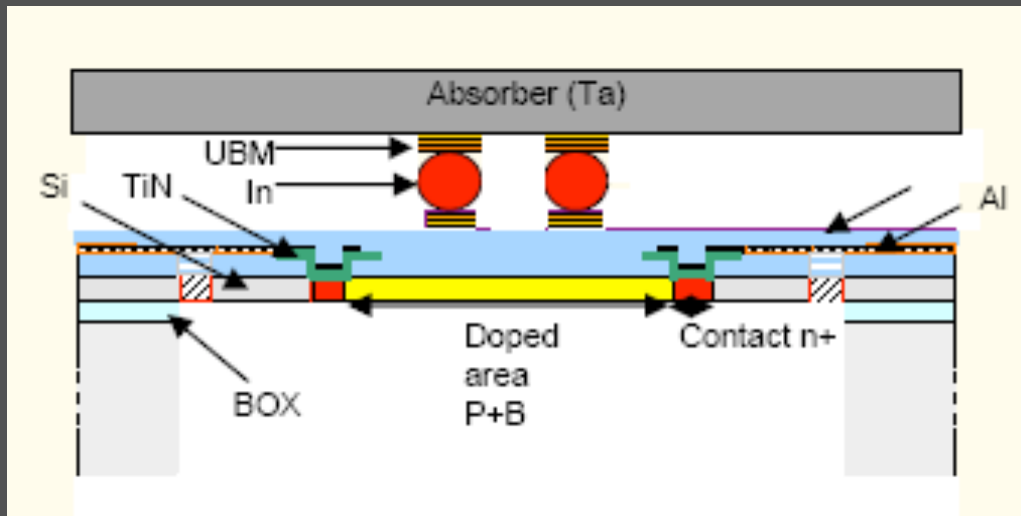
SRON Netherlands Institute for Space Research, Sorbonnelaan 2, 3584 CA Utrecht, Netherlands, ^aIMM-CSIC, Madrid, Spain, ^bIFCA, Santander, Spain, ^cUniversity of Murcia, Murcia, Spain, ^dIMCA, Zaragoza, Spain, ^eINA, Zaragoza, Spain, ^fIMM-CSIC, Barcelona, Spain, ^gPSI, Villigen, Switzerland, ^hINFN/University of Genua, Genua, Italy, ⁱThales Alenia Spazio, Milano, Italy, ^jIASF/INAF, Rome, Italy, ^kIFN-CNR Rome, Rome, Italy, ^lVTT-Sensors, Espoo, Finland, ^mPTB, Berlin, Germany, ⁿTokyo Metropolitan University, Tokyo, Japan, ^oISAS/JAXA, Tokyo, Japan, ^pSystematic Design B.V., Delft, Netherlands, ^qISDC, Versoix, Switzerland

Si-doped X-ray Micro-calorimeter at CEA-Saclay

Herschel heritage: Developments by CEA-Saclay and LETI, Grenoble

Contributed paper by Claude Pigot

Fully integrated sensor with read-out multiplexer



Results: - Impedance of 8X8 sensor matrix in the right range with good sensitivity
- Integration of absorber matrix onto sensor matrix promising

Next steps: April 2008: First 8X8 array with freed Sensor & Absorber
End 2008: 1st Iteration Cold Electronics

Pro: Fully integrated system with multiplexed read-out

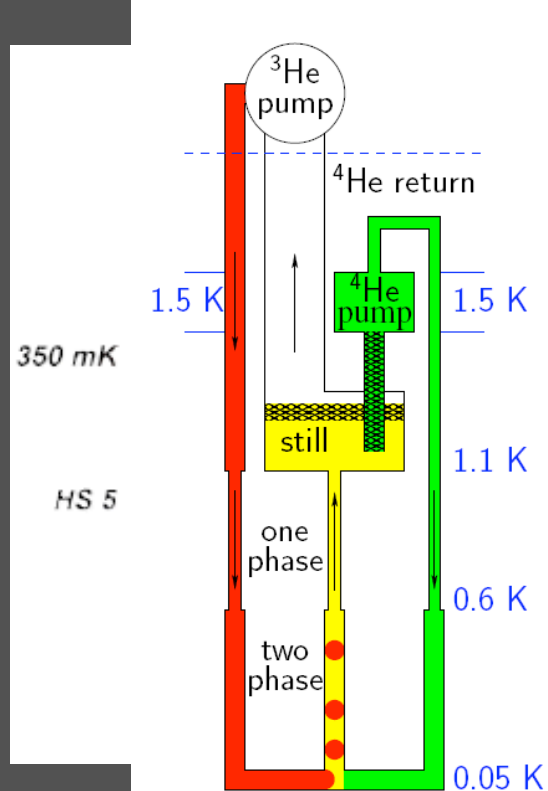
Con: Till now no X-ray performance data, use of Ta-absorbers by other teams failed, potentially slow response, developments late for XEUS.

Narrow Field Imager - TES-based Micro-Calorimeter

Interface with satellite cryostat at 2.5 K with 10 mW cooling power

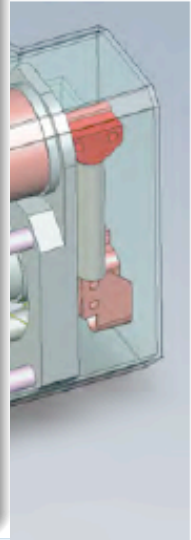
Options under development:

Closed cycle cooling / 1 stage ADR (CEA, Orsted, ESA, UxM)
 30 W and 31 kg for 1 μ W during 30 hours
 25 W and 5 kg for 1 μ W during 30 hours

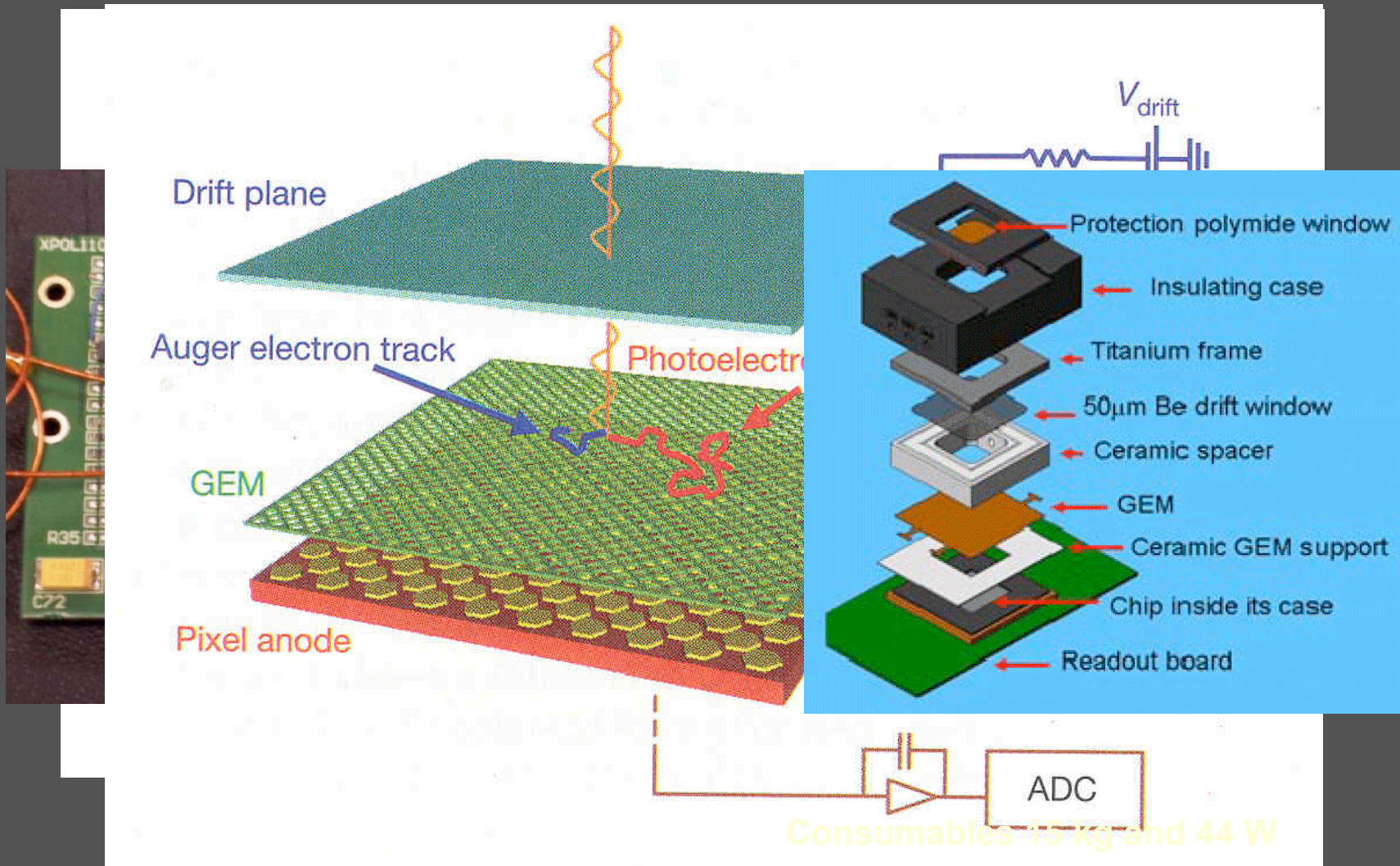


XEUS - NFI X-ray experiment

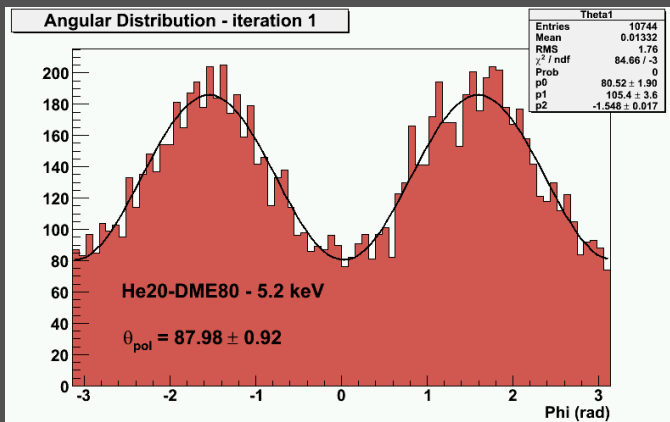
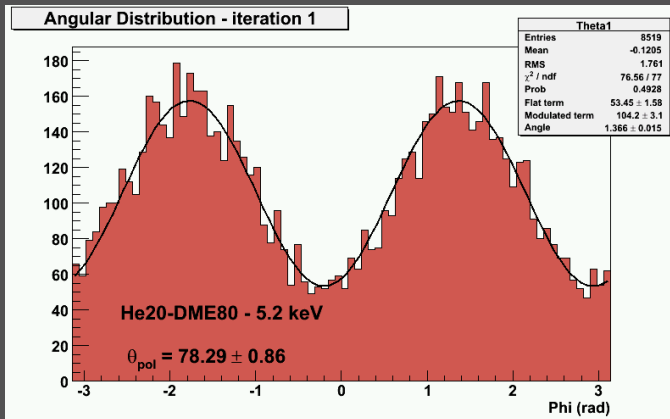
- requires 1 μ W at 50 mK for ADR
 - CCDR meets requirement with $\dot{n}_3 = 30 \mu\text{mole/s}$, $\dot{n}_4 = 120 \mu\text{mole/s}$ and a heat exchanger of $L = 9 \text{ m}$ and $d = 0.4 \text{ mm}$
 - better thermalization of wiring reduces required cooling power for CCDR
- precooling stage of XEUS delivers 10 mW at 2.5 K
 - CCDR needs 5 mW at 1.5-1.8(?) K
 - **solution:** ^3He Joule-Thompson expansion from 15 K or with SPICA technology



X-ray Polarimeter

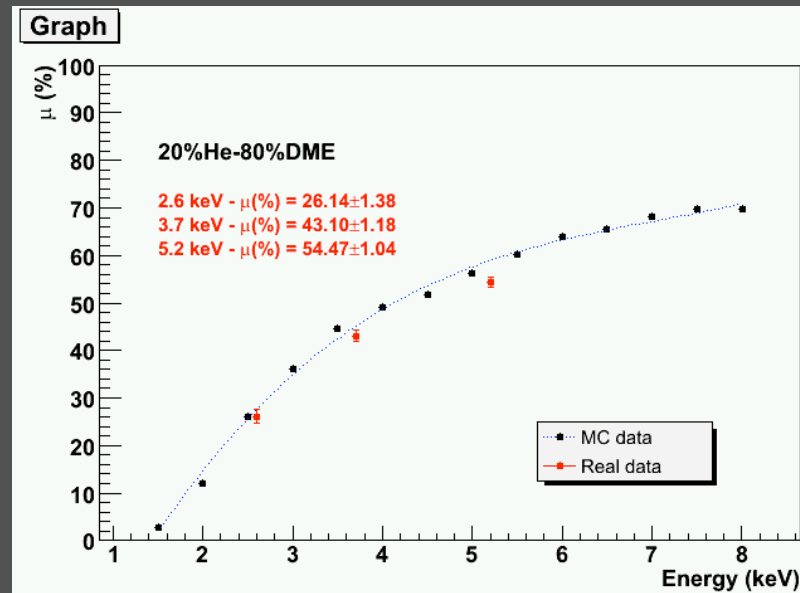
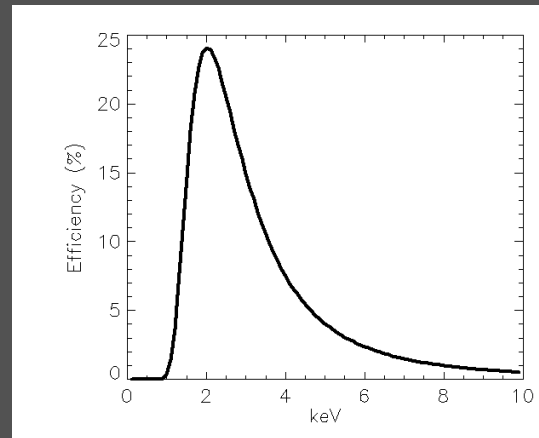


XPOL - Performance



5.2 keV polarized photons for two angular rotations of the polarizer showing the good angular sensitivity.

SRON



The modulation factor measured at 2.6 keV, 3.7 keV and 5.2 keV compared with the Monte Carlo previsions.